

HETERO JUNCTION FIELD EFFECT TRANSISTOR NE3517S03

K-BAND SUPER LOW NOISE AMPLIFIER N-CHANNEL GaAs HJ-FET

FEATURES

- Super low noise figure, high associated gain
NF = 0.7 dB TYP., $G_a = 13.5$ dB TYP. @ $f = 20$ GHz
- K-band Micro-X plastic (S03) package

APPLICATIONS

- 20 GHz band DBS LNB
- Other K-band communication systems

ORDERING INFORMATION

Part Number	Order Number	Package	Quantity	Marking	Supplying Form
NE3517S03-T1C	NE3517S03-T1C-A	S03 (Pb-Free)	2 kpcs/reel	E	<ul style="list-style-type: none"> • 8 mm wide embossed taping • Pin 4 (Gate) faces the perforation side of the tape
NE3517S03-T1D	NE3517S03-T1D-A		10 kpcs/reel		

Remark To order evaluation samples, please contact your nearby sales office.
Part number for sample order: NE3517S03

ABSOLUTE MAXIMUM RATINGS ($T_A = +25^\circ\text{C}$)

Parameter	Symbol	Ratings	Unit
Drain to Source Voltage	V_{DS}	4	V
Gate to Source Voltage	V_{GS}	-3	V
Drain Current	I_D	I_{DSS}	mA
Gate Current	I_G	100	μA
Total Power Dissipation	P_{tot}^{Note}	165	mW
Channel Temperature	T_{ch}	+125	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +125	$^\circ\text{C}$

Note Mounted on $1.08 \text{ cm}^2 \times 1.0 \text{ mm}$ (t) glass epoxy PCB

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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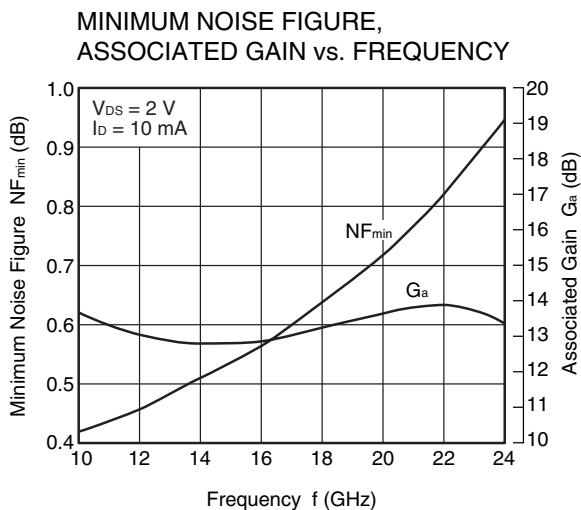
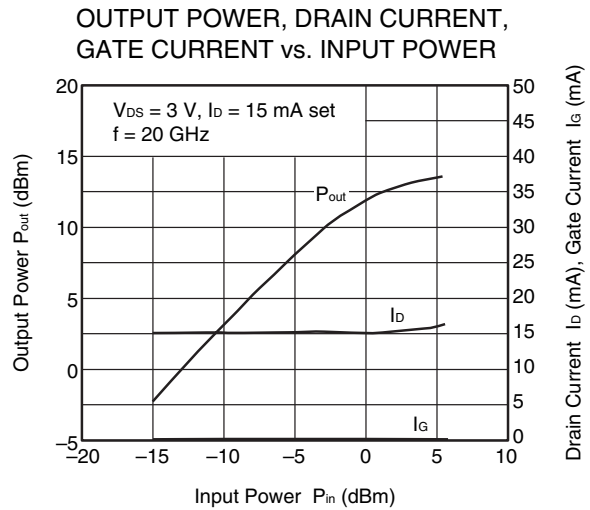
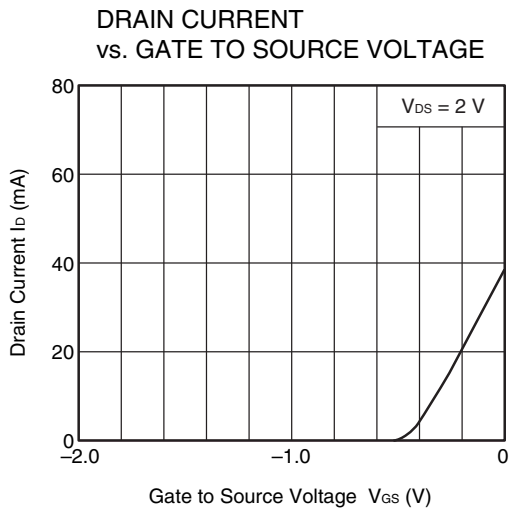
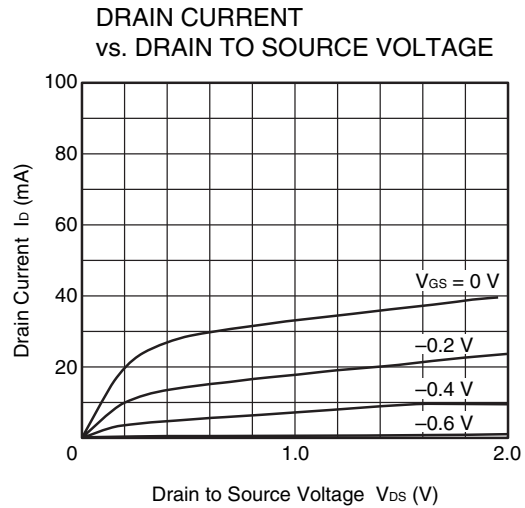
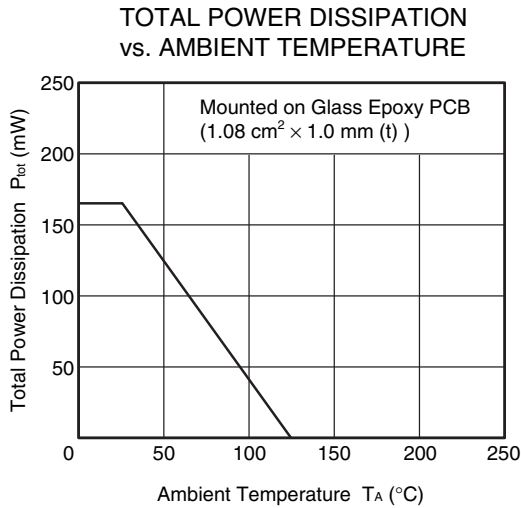
RECOMMENDED OPERATING CONDITIONS (T_A = +25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Drain to Source Voltage	V _{DS}	1	2	3	V
Drain Current	I _D	5	10	15	mA
Input Power	P _{in}	–	–	0	dBm

ELECTRICAL CHARACTERISTICS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Gate to Source Leak Current	I _{GSO}	V _{GS} = –3 V	–	0.5	10	μA
Saturated Drain Current	I _{DSS}	V _{DS} = 2 V, V _{GS} = 0 V	25	40	70	mA
Gate to Source Cutoff Voltage	V _{GS (off)}	V _{DS} = 2 V, I _D = 100 μA	–0.2	–0.7	–1.5	V
Transconductance	g _m	V _{DS} = 2 V, I _D = 10 mA	40	55	–	mS
Noise Figure	NF	V _{DS} = 2 V, I _D = 10 mA, f = 20 GHz	–	0.7	1.0	dB
Associated Gain	G _a		11.0	13.5	–	dB

TYPICAL CHARACTERISTICS (T_A = +25°C, unless otherwise specified)



Remark The graphs indicate nominal characteristics.

S-PARAMETERS

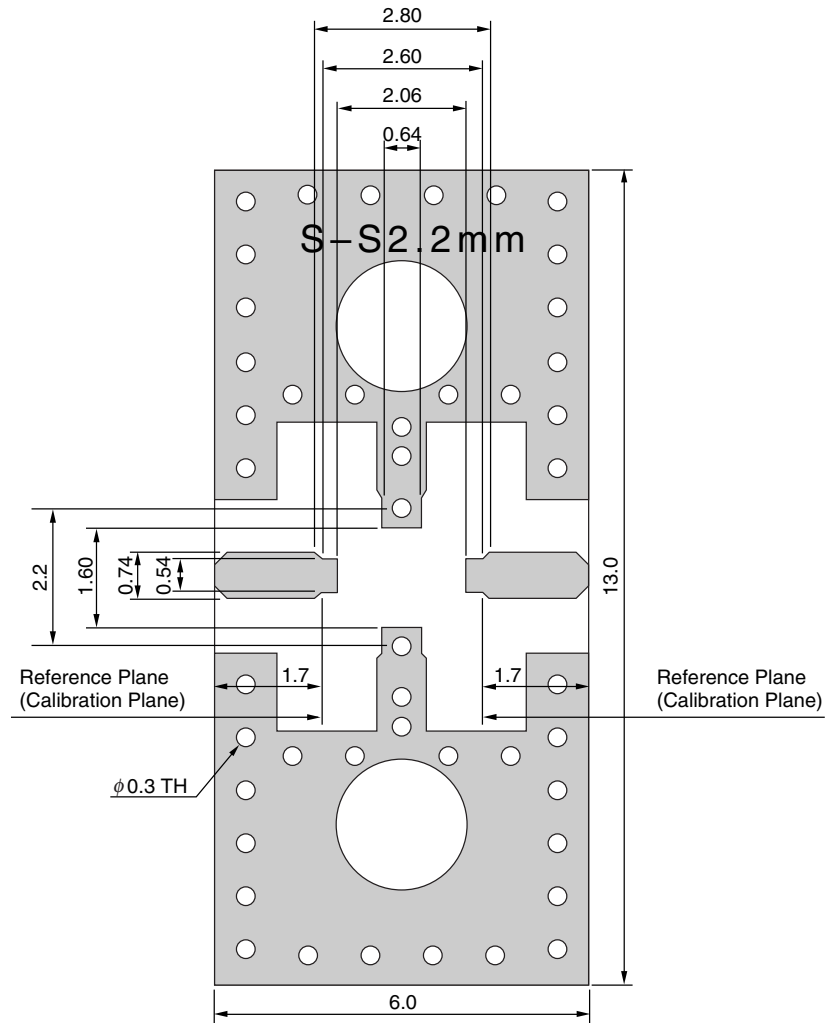
S-parameters and noise parameters are provided on our Web site in a format (S2P) that enables the direct import of the parameters to microwave circuit simulators without the need for keyboard inputs.

Click here to download S-parameters.

[RF and Microwave] → [Device Parameters]

URL <http://www.necel.com/microwave/en/>

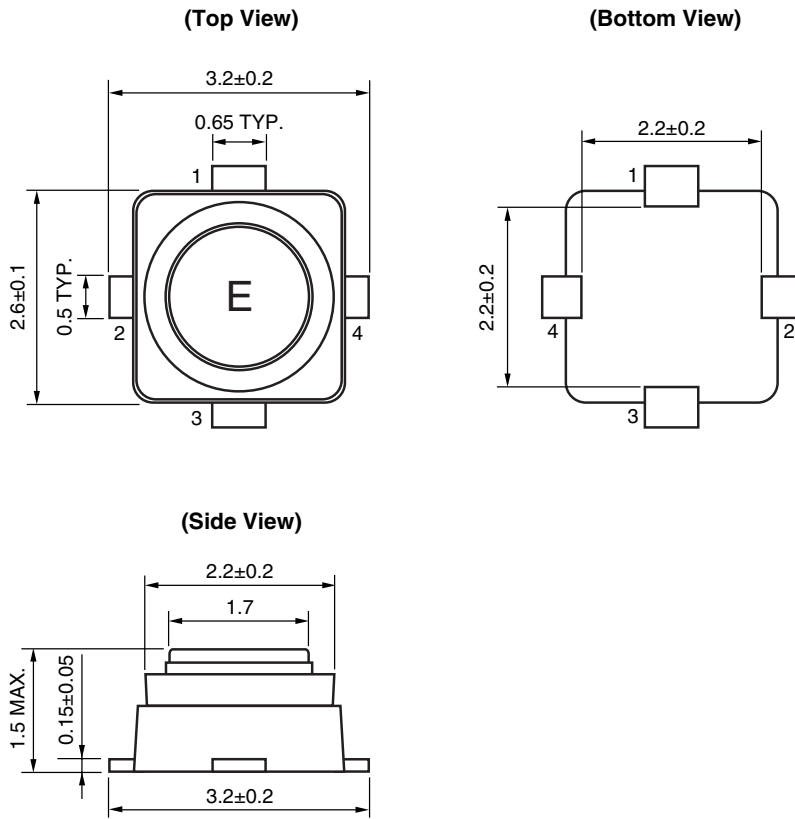
RF MEASURING LAYOUT PATTERN (REFERENCE ONLY) (UNIT: mm)



RT/duroid 5880/ROGERS
 t = 0.254 mm
 er = 2.20
 tan delta = 0.0009 @10 GHz
 Au-flash plate

PACKAGE DIMENSIONS

S03 (UNIT: mm)



PIN CONNECTIONS

- 1. Source
- 2. Drain
- 3. Source
- 4. Gate

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below
	Time at peak temperature	: 10 seconds or less
	Time at temperature of 220°C or higher	: 60 seconds or less
	Preheating time at 120 to 180°C	: 120±30 seconds
	Maximum number of reflow processes	: 3 times
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below
Partial Heating	Peak temperature (terminal temperature)	: 350°C or below
	Soldering time (per side of device)	: 3 seconds or less
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below

Caution Do not use different soldering methods together (except for partial heating).

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Caution	GaAs Products	<p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none">• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.<ol style="list-style-type: none">1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.• Do not burn, destroy, cut, crush, or chemically dissolve the product.• Do not lick the product or in any way allow it to enter the mouth.
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